3. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74LVC8T245PW	-40 °C to +125 °C	TSSOP24	plastic thin shrink small outline package; 24 leads; body width 4.4 mm	SOT355-1
74LVCH8T245PW				
74LVC8T245BQ	-40 °C to +125 °C	DHVQFN24	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 24 terminals; body 3.5 × 5.5 × 0.85 mm	SOT815-1
74LVCH8T245BQ				
74LVC8T245BZ	-40 °C to +125 °C	DHXQFN24	plastic, leadless dual in-line compatible thermal enhanced extreme thin quad flat package; no leads; 24 terminals; 0.4 mm pitch; body 2 mm × 4 mm × 0.48 mm	SOT8024-1

4. Functional diagram

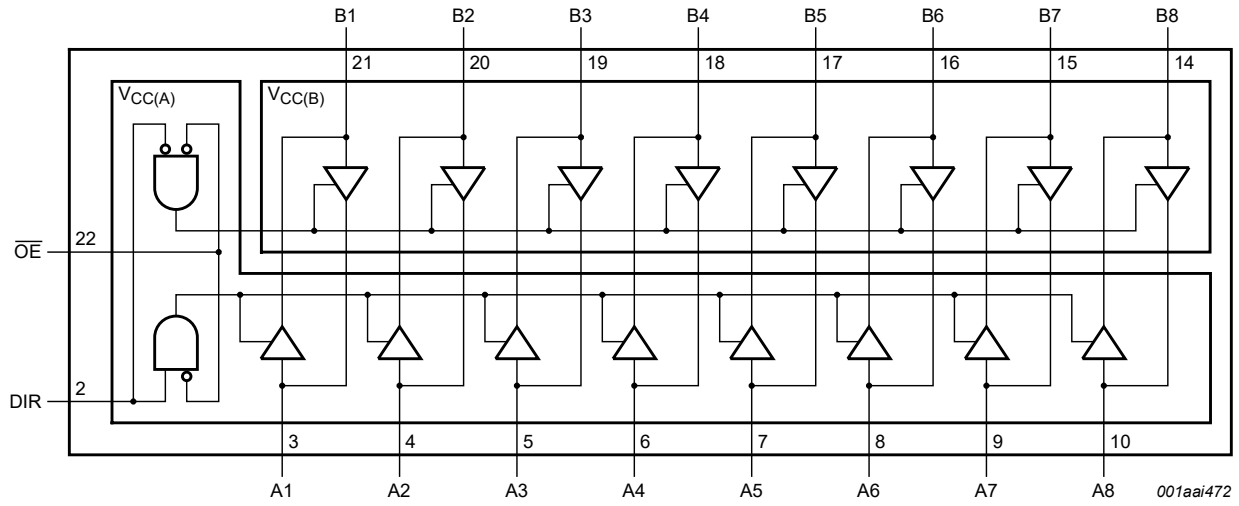


Fig. 1. Logic symbol

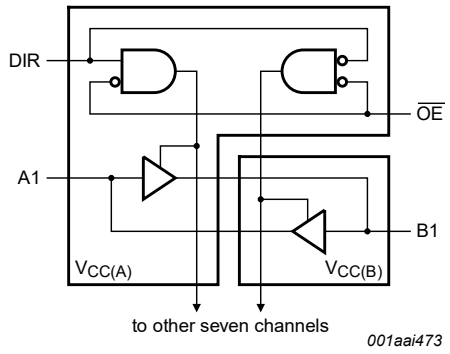


Fig. 2. Logic diagram (one channel)

5. Pinning information

5.1. Pinning

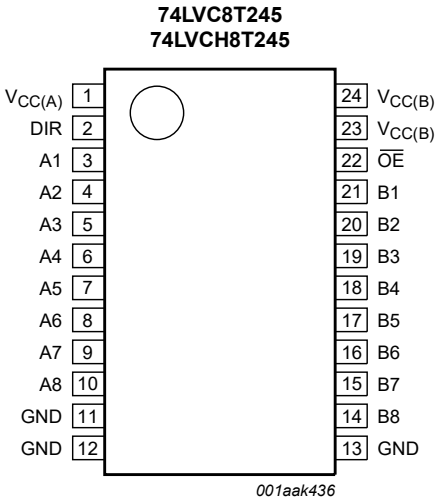
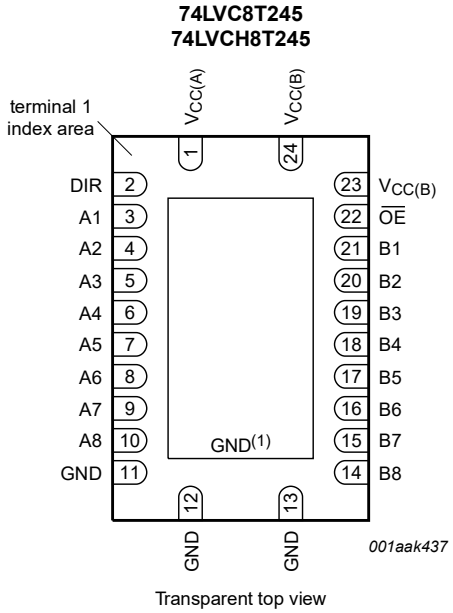


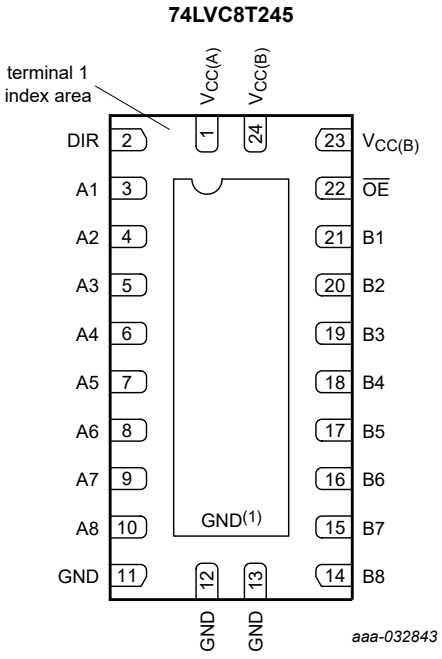
Fig. 3. Pin configuration SOT355-1 (TSSOP24)



Transparent top view

(1) This is not a ground pin. There is no electrical or mechanical requirement to solder the pad. In case soldered, the solder land should remain floating or connected to GND.

Fig. 4. Pin configuration SOT815-1 (DHVQFN24)



Transparent top view

(1) This is not a ground pin. There is no electrical or mechanical requirement to solder the pad. In case soldered, the solder land should remain floating or connected to GND.

Fig. 5. Pin configuration SOT8024-1 (DHXQFN24)

5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
$V_{CC(A)}$	1	supply voltage A (An inputs/outputs, $\overline{OE}$ and DIR inputs are referenced to $V_{CC(A)}$)
DIR	2	direction control
A1, A2, A3, A4, A5, A6, A7, A8	3, 4, 5, 6, 7, 8, 9, 10	data input or output
GND [1]	11, 12, 13	ground (0 V)
B1, B2, B3, B4, B5, B6, B7, B8	21, 20, 19, 18, 17, 16, 15, 14	data input or output
$\overline{OE}$	22	output enable input (active LOW)
$V_{CC(B)}$	23, 24	supply voltage B (Bn inputs/outputs are referenced to $V_{CC(B)}$)

[1] All GND pins must be connected to ground (0 V).

6. Functional description

Table 3. Function table

H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

Supply voltage	Input		Input/output [1]	
$V_{CC(A)}$, $V_{CC(B)}$	$\overline{OE}$ [2]	DIR [2]	An [2]	Bn [2]
1.2 V to 5.5 V	L	L	An = Bn	input
1.2 V to 5.5 V	L	H	input	Bn = An
1.2 V to 5.5 V	H	X	Z	Z
GND [1]	X	X	Z	Z

[1] If at least one of $V_{CC(A)}$ or $V_{CC(B)}$ is at GND level, the device goes into suspend mode.
[2] The An inputs/outputs, DIR and $\overline{OE}$ input circuit is referenced to $V_{CC(A)}$; The Bn inputs/outputs circuit is referenced to $V_{CC(B)}$.

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
$V_{CC(A)}$	supply voltage A			-0.5	+6.5	V
$V_{CC(B)}$	supply voltage B			-0.5	+6.5	V
I_{IK}	input clamping current	V_I < 0 V		-50	-	mA
V_I	input voltage		[1]	-0.5	+6.5	V
I_{OK}	output clamping current	V_O < 0 V		-50	-	mA
V_O	output voltage	Active mode	[1] [2] [3]	-0.5	V_{CCO} + 0.5	V
		Suspend or 3-state mode	[1]	-0.5	+6.5	V
I_O	output current	V_O = 0 V to V_{CCO}	[2]	-	±50	mA
I_{CC}	supply current	$I_{CC(A)}$ or $I_{CC(B)}$; per V_{CC} pin		-	100	mA
I_{GND}	ground current	per GND pin		-100	-	mA
T_{stg}	storage temperature			-65	+150	°C
P_{tot}	total power dissipation	T_{amb} = -40 °C to +125 °C				
		SOT355-1; SOT815-1	[4]	-	500	mW
		SOT8024-1		-	250	mW

[1] The minimum input voltage ratings and output voltage ratings may be exceeded if the input and output current ratings are observed.
[2] V_{CCO} is the supply voltage associated with the output port.
[3] V_{CCO} + 0.5 V should not exceed 6.5 V.
[4] For SOT355-1 (TSSOP24) package: P_{tot} derates linearly with 12.4 mW/K above 110 °C.
For SOT815-1 (DHVQFN24) package: P_{tot} derates linearly with 15.0 mW/K above 117 °C.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions		Min	Max	Unit
$V_{CC(A)}$	supply voltage A			1.2	5.5	V
$V_{CC(B)}$	supply voltage B			1.2	5.5	V
V_I	input voltage			0	5.5	V
V_O	output voltage	Active mode	[1]	0	V_{CCO}	V
		Suspend or 3-state mode		0	5.5	V
T_{amb}	ambient temperature			-40	+125	°C
Δt/ΔV	input transition rise and fall rate	V_{CCI} = 1.2 V	[2]	-	20	ns/V
		V_{CCI} = 1.4 V to 1.95 V		-	20	ns/V
		V_{CCI} = 2.3 V to 2.7 V		-	20	ns/V
		V_{CCI} = 3 V to 3.6 V		-	10	ns/V
		V_{CCI} = 4.5 V to 5.5 V		-	5	ns/V

[1] V_{CCO} is the supply voltage associated with the output port.
[2] V_{CCI} is the supply voltage associated with the input port.

9. Static characteristics

Table 6. Typical static characteristics at T_{amb} = 25 °C

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
V_{OH}	HIGH-level output voltage	$V_I = V_{IH}$ or V_{IL}	[1]				
		I_O = -3 mA; V_{CCO} = 1.2 V		-	1.09	-	V
V_{OL}	LOW-level output voltage	$V_I = V_{IH}$ or V_{IL}					
		I_O = 3 mA; V_{CCO} = 1.2 V	[1]	-	0.07	-	V
I_I	input leakage current	DIR, $\overline{OE}$ input; V_I = 0 V to 5.5 V; V_{CCI} = 1.2 V to 5.5 V	[2]	-	-	±1	µA
I_{BHL}	bus hold LOW current	A or B port; V_I = 0.42 V; V_{CCI} = 1.2 V	[2]	-	19	-	µA
I_{BHH}	bus hold HIGH current	A or B port; V_I = 0.78 V; V_{CCI} = 1.2 V	[2]	-	-19	-	µA
I_{BHLO}	bus hold LOW overdrive current	A or B port; V_{CCI} = 1.2 V	[2] [3]	-	19	-	µA
I_{BHHO}	bus hold HIGH overdrive current	A or B port; V_{CCI} = 1.2 V	[2] [3]	-	-19	-	µA
I_{OZ}	OFF-state output current	A or B port; V_O = 0 V or V_{CCO}; V_{CCO} = 1.2 V to 5.5 V	[1]	-	-	±1	µA
		suspend mode A port; V_O = 0 V or V_{CCO}; $V_{CC(A)}$ = 5.5 V; $V_{CC(B)}$ = 0 V	[1]	-	-	±1	µA
		suspend mode B port; V_O = 0 V or V_{CCO}; $V_{CC(A)}$ = 0 V; $V_{CC(B)}$ = 5.5 V	[1]	-	-	±1	µA
I_{OFF}	power-off leakage current	A port; V_I or V_O = 0 V to 5.5 V; $V_{CC(A)}$ = 0 V; $V_{CC(B)}$ = 1.2 V to 5.5 V		-	-	±1	µA
		B port; V_I or V_O = 0 V to 5.5 V; $V_{CC(B)}$ = 0 V; $V_{CC(A)}$ = 1.2 V to 5.5 V		-	-	±1	µA
C_I	input capacitance	DIR, $\overline{OE}$ input; V_I = 0 V or 3.3 V; $V_{CC(A)}$ = 3.3 V		-	3	-	pF
$C_{I/O}$	input/output capacitance	A and B port; V_O = 3.3 V or 0 V; $V_{CC(A)} = V_{CC(B)}$ = 3.3 V		-	6.5	-	pF

[1] V_{CCO} is the supply voltage associated with the output port.
[2] V_{CCI} is the supply voltage associated with the data input port.
[3] To guarantee the node switches, an external driver must source/sink at least I_{BHLO} / I_{BHHO} when the input is in the range V_{IL} to V_{IH}.

Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Max	Min	Max	
V_{IH}	HIGH-level input voltage	data input [1]					
		V_{CCI} = 1.2 V	$0.8V_{CCI}$	-	$0.8V_{CCI}$	-	V
		V_{CCI} = 1.4 V to 1.95 V	$0.65V_{CCI}$	-	$0.65V_{CCI}$	-	V
		V_{CCI} = 2.3 V to 2.7 V	1.7	-	1.7	-	V
		V_{CCI} = 3.0 V to 3.6 V	2.0	-	2.0	-	V
		V_{CCI} = 4.5 V to 5.5 V	$0.7V_{CCI}$	-	$0.7V_{CCI}$	-	V
		DIR, $\overline{OE}$ input					
		V_{CCI} = 1.2 V	$0.8V_{CC(A)}$	-	$0.8V_{CC(A)}$	-	V
		V_{CCI} = 1.4 V to 1.95 V	$0.65V_{CC(A)}$	-	$0.65V_{CC(A)}$	-	V
		V_{CCI} = 2.3 V to 2.7 V	1.7	-	1.7	-	V
		V_{CCI} = 3.0 V to 3.6 V	2.0	-	2.0	-	V
		V_{CCI} = 4.5 V to 5.5 V	$0.7V_{CC(A)}$	-	$0.7V_{CC(A)}$	-	V
V_{IL}	LOW-level input voltage	data input [1]					
		V_{CCI} = 1.2 V	-	$0.2V_{CCI}$	-	$0.2V_{CCI}$	V
		V_{CCI} = 1.4 V to 1.95 V	-	$0.35V_{CCI}$	-	$0.35V_{CCI}$	V
		V_{CCI} = 2.3 V to 2.7 V	-	0.7	-	0.7	V
		V_{CCI} = 3.0 V to 3.6 V	-	0.8	-	0.8	V
		V_{CCI} = 4.5 V to 5.5 V	-	$0.3V_{CCI}$	-	$0.3V_{CCI}$	V
		DIR, $\overline{OE}$ input					
		V_{CCI} = 1.2 V	-	$0.2V_{CC(A)}$	-	$0.2V_{CC(A)}$	V
		V_{CCI} = 1.4 V to 1.95 V	-	$0.35V_{CC(A)}$	-	$0.35V_{CC(A)}$	V
		V_{CCI} = 2.3 V to 2.7 V	-	0.7	-	0.7	V
		V_{CCI} = 3.0 V to 3.6 V	-	0.8	-	0.8	V
		V_{CCI} = 4.5 V to 5.5 V	-	$0.3V_{CC(A)}$	-	$0.3V_{CC(A)}$	V
V_{OH}	HIGH-level output voltage	$V_I = V_{IH}$					
		I_O = -100 µA; V_{CCO} = 1.2 V to 4.5 V [2]	V_{CCO} - 0.1	-	V_{CCO} - 0.1	-	V
		I_O = -6 mA; V_{CCO} = 1.4 V	1.0	-	1.0	-	V
		I_O = -8 mA; V_{CCO} = 1.65 V	1.2	-	1.2	-	V
		I_O = -12 mA; V_{CCO} = 2.3 V	1.9	-	1.9	-	V
		I_O = -24 mA; V_{CCO} = 3.0 V	2.4	-	2.4	-	V
		I_O = -32 mA; V_{CCO} = 4.5 V	3.8	-	3.8	-	V
V_{OL}	LOW-level output voltage	$V_I = V_{IL}$ [2]					
		I_O = 100 µA; V_{CCO} = 1.2 V to 4.5 V	-	0.1	-	0.1	V
		I_O = 6 mA; V_{CCO} = 1.4 V	-	0.3	-	0.3	V
		I_O = 8 mA; V_{CCO} = 1.65 V	-	0.45	-	0.45	V
		I_O = 12 mA; V_{CCO} = 2.3 V	-	0.3	-	0.3	V
		I_O = 24 mA; V_{CCO} = 3.0 V	-	0.55	-	0.55	V
		I_O = 32 mA; V_{CCO} = 4.5 V	-	0.55	-	0.55	V
I_I	input leakage current	DIR, $\overline{OE}$ input; V_I = 0 V to 5.5 V; V_{CCI} = 1.2 V to 5.5 V	-	±2	-	±10	µA

Symbol	Parameter	Conditions	-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Max	Min	Max	
I_{BHL}	bus hold LOW current	A or B port [1]					
		V_I = 0.49 V; V_{CCI} = 1.4 V	15	-	10	-	µA
		V_I = 0.58 V; V_{CCI} = 1.65 V	25	-	20	-	µA
		V_I = 0.70 V; V_{CCI} = 2.3 V	45	-	45	-	µA
		V_I = 0.80 V; V_{CCI} = 3.0 V	100	-	80	-	µA
		V_I = 1.35 V; V_{CCI} = 4.5 V	100	-	100	-	µA
I_{BHH}	bus hold HIGH current	A or B port [1]					
		V_I = 0.91 V; V_{CCI} = 1.4 V	-15	-	-10	-	µA
		V_I = 1.07 V; V_{CCI} = 1.65 V	-25	-	-20	-	µA
		V_I = 1.70 V; V_{CCI} = 2.3 V	-45	-	-45	-	µA
		V_I = 2.00 V; V_{CCI} = 3.0 V	-100	-	-80	-	µA
		V_I = 3.15 V; V_{CCI} = 4.5 V	-100	-	-100	-	µA
I_{BHLO}	bus hold LOW overdrive current	A or B port [1] [3]					
		V_{CCI} = 1.6 V	125	-	125	-	µA
		V_{CCI} = 1.95 V	200	-	200	-	µA
		V_{CCI} = 2.7 V	300	-	300	-	µA
		V_{CCI} = 3.6 V	500	-	500	-	µA
		V_{CCI} = 5.5 V	900	-	900	-	µA
I_{BHHO}	bus hold HIGH overdrive current	A or B port [1] [3]					
		V_{CCI} = 1.6 V	-125	-	-125	-	µA
		V_{CCI} = 1.95 V	-200	-	-200	-	µA
		V_{CCI} = 2.7 V	-300	-	-300	-	µA
		V_{CCI} = 3.6 V	-500	-	-500	-	µA
		V_{CCI} = 5.5 V	-900	-	-900	-	µA
I_{OZ}	OFF-state output current	A or B port; V_O = 0 V or V_{CCO}; V_{CCO} = 1.2 V to 5.5 V [2]	-	±2	-	±10	µA
		suspend mode A port; V_O = 0 V or V_{CCO}; $V_{CC(A)}$ = 5.5 V; $V_{CC(B)}$ = 0 V [2]	-	±2	-	±10	µA
		suspend mode B port; V_O = 0 V or V_{CCO}; $V_{CC(A)}$ = 0 V; $V_{CC(B)}$ = 5.5 V [2]	-	±2	-	±10	µA
I_{OFF}	power-off leakage current	A port; V_I or V_O = 0 V to 5.5 V; $V_{CC(A)}$ = 0 V; $V_{CC(B)}$ = 1.2 V to 5.5 V	-	±2	-	±10	µA
		B port; V_I or V_O = 0 V to 5.5 V; $V_{CC(B)}$ = 0 V; $V_{CC(A)}$ = 1.2 V to 5.5 V	-	±2	-	±10	µA

Symbol	Parameter	Conditions	-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Max	Min	Max	
I_{CC}	supply current	A port; V_I = 0 V or V_{CCI}; I_O = 0 A [1]					
		$V_{CC(A)}$, $V_{CC(B)}$ = 1.2 V to 5.5 V	-	15	-	20	µA
		$V_{CC(A)}$ = 5.5 V; $V_{CC(B)}$ = 0 V	-	15	-	20	µA
		$V_{CC(A)}$ = 0 V; $V_{CC(B)}$ = 5.5 V	-2	-	-4	-	µA
		B port; V_I = 0 V or V_{CCI}; I_O = 0 A					
		$V_{CC(A)}$, $V_{CC(B)}$ = 1.2 V to 5.5 V	-	15	-	20	µA
		$V_{CC(B)}$ = 0 V; $V_{CC(A)}$ = 5.5 V	-2	-	-4	-	µA
		$V_{CC(B)}$ = 5.5 V; $V_{CC(A)}$ = 0 V	-	15	-	20	µA
		A plus B port ($I_{CC(A)}$ + $I_{CC(B)}$); I_O = 0 A; V_I = 0 V or V_{CCI}					
		$V_{CC(A)}$, $V_{CC(B)}$ = 1.2 V to 5.5 V	-	25	-	30	µA
ΔI_{CC}	additional supply current	per input; $V_{CC(A)}$, $V_{CC(B)}$ = 3.0 V to 5.5 V					
		DIR and $\overline{OE}$ input; DIR or $\overline{OE}$ input at $V_{CC(A)}$ - 0.6 V; A port at $V_{CC(A)}$ or GND; B port = open	-	50	-	75	µA
		A port; A port at $V_{CC(A)}$ - 0.6 V; DIR at $V_{CC(A)}$; B port = open [4]	-	50	-	75	µA
		B port; B port at $V_{CC(B)}$ - 0.6 V; DIR at GND; A port = open [4]	-	50	-	75	µA

[1] V_{CCI} is the supply voltage associated with the data input port.
[2] V_{CCO} is the supply voltage associated with the output port.
[3] To guarantee the node switches, an external driver must source/sink at least I_{BHLO} / I_{BHHO} when the input is in the range V_{IL} to V_{IH}.
[4] For non bus hold parts only (74LVC8T245).

10. Dynamic characteristics

Table 8. Typical dynamic characteristics at $V_{CC(A)}$ = 1.2 V and T_{amb} = 25 °C

Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 8; for wave forms see Fig. 6 and Fig. 7. [1]

Symbol	Parameter	Conditions	$V_{CC(B)}$						Unit
			1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	5.0 V	
t_{pd}	propagation delay	An to Bn	11.0	8.5	7.4	6.2	5.7	5.4	ns
		Bn to An	11.0	10.0	9.5	9.1	8.9	8.9	ns
t_{dis}	disable time	$\overline{OE}$ to An	9.5	9.5	9.5	9.5	9.5	9.5	ns
		$\overline{OE}$ to Bn	10.2	8.2	7.8	6.7	7.3	6.4	ns
t_{en}	enable time	$\overline{OE}$ to An	13.5	13.5	13.5	13.5	13.5	13.5	ns
		$\overline{OE}$ to Bn	13.6	10.3	8.9	7.5	7.1	7.0	ns

[1] t_{pd} is the same as t_{PLH} and t_{PHL}; t_{dis} is the same as t_{PLZ} and t_{PHZ}; t_{en} is the same as t_{PZL} and t_{PZH}.

Table 9. Typical dynamic characteristics at $V_{CC(B)}$ = 1.2 V and T_{amb} = 25 °C

Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 8; for wave forms see Fig. 6 and Fig. 7. [1]

Symbol	Parameter	Conditions	$V_{CC(A)}$						Unit
			1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	5.0 V	
t_{pd}	propagation delay	An to Bn	11.0	10.0	9.5	9.1	8.9	8.8	ns
		Bn to An	11.0	8.5	7.3	6.2	5.7	5.4	ns
t_{dis}	disable time	$\overline{OE}$ to An	9.5	6.8	5.4	3.8	4.1	3.1	ns
		$\overline{OE}$ to Bn	10.2	9.1	8.6	8.1	7.8	7.8	ns
t_{en}	enable time	$\overline{OE}$ to An	13.5	9.0	6.9	4.8	3.8	3.2	ns
		$\overline{OE}$ to Bn	13.6	12.5	12.0	11.5	11.4	11.4	ns

[1] t_{pd} is the same as t_{PLH} and t_{PHL}; t_{dis} is the same as t_{PLZ} and t_{PHZ}; t_{en} is the same as t_{PZL} and t_{PZH}.

Table 10. Typical power dissipation capacitance at $V_{CC(A)} = V_{CC(B)}$ and T_{amb} = 25 °C

Voltages are referenced to GND (ground = 0 V). [1] [2]

Symbol	Parameter	Conditions	$V_{CC(A)}$ and $V_{CC(B)}$				Unit
			1.8 V	2.5 V	3.3 V	5.0 V	
C_{PD}	power dissipation capacitance	A port: (direction A to B); B port: (direction B to A)	1	1	1	2	pF
		A port: (direction B to A); B port: (direction A to B)	13	13	13	13	pF

[1] C_{PD} is used to determine the dynamic power dissipation (P_D in µW).
$P_D = C_{PD} \times V_{CC}{}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}{}^2 \times f_o)$ where:
f_i = input frequency in MHz;
f_o = output frequency in MHz;
C_L = load capacitance in pF;
V_{CC} = supply voltage in V;
N = number of inputs switching;
$\Sigma(C_L \times V_{CC}{}^2 \times f_o)$ = sum of the outputs.

[2] f_i = 10 MHz; V_I = GND to V_{CC}; $t_r = t_f$ = 1 ns; C_L = 0 pF; $R_L = \infty\ \Omega$.

Table 11. Dynamic characteristics for temperature range -40 °C to +85 °C

Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 8; for waveforms see Fig. 6 and Fig. 7. [1]

Symbol	Parameter	Conditions	$V_{CC(B)}$										Unit
			1.5 V ± 0.1 V		1.8 V ± 0.15 V		2.5 V ± 0.2 V		3.3 V ± 0.3 V		5.0 V ± 0.5 V		
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
$V_{CC(A)}$ = 1.5 V ± 0.1 V													
t_{pd}	propagation delay	An to Bn	1.7	27	1.7	23	1.3	18	1.0	15	0.8	13	ns
		Bn to An	0.9	27	0.9	25	0.8	23	0.7	23	0.7	22	ns
t_{dis}	disable time	$\overline{OE}$ to An	1.5	30	1.5	30	1.5	30	1.5	30	1.4	30	ns
		$\overline{OE}$ to Bn	2.4	34	2.4	33	1.9	15	1.7	14	1.3	12	ns
t_{en}	enable time	$\overline{OE}$ to An	0.4	34	0.4	34	0.4	34	0.4	34	0.4	34	ns
		$\overline{OE}$ to Bn	1.8	36	1.8	34	1.5	18	1.2	15	0.9	13	ns
$V_{CC(A)}$ = 1.8 V ± 0.15 V													
t_{pd}	propagation delay	An to Bn	1.7	25	1.7	21.9	1.3	9.2	1.0	7.4	0.8	7.1	ns
		Bn to An	0.9	23	0.9	23.8	0.8	23.6	0.7	23.4	0.7	23.4	ns
t_{dis}	disable time	$\overline{OE}$ to An	1.5	30	1.5	29.6	1.5	29.4	1.5	29.3	1.4	29.2	ns
		$\overline{OE}$ to Bn	2.4	33	2.4	32.2	1.9	13.1	1.7	12.0	1.3	10.3	ns
t_{en}	enable time	$\overline{OE}$ to An	0.4	24	0.4	24.0	0.4	23.8	0.4	23.7	0.4	23.7	ns
		$\overline{OE}$ to Bn	1.8	34	1.8	32.0	1.5	16.0	1.2	12.6	0.9	10.8	ns
$V_{CC(A)}$ = 2.5 V ± 0.2 V													
t_{pd}	propagation delay	An to Bn	1.5	23	1.5	21.4	1.2	9.0	0.8	6.2	0.6	4.8	ns
		Bn to An	1.2	18	1.2	9.3	1.0	9.1	1.0	8.9	0.9	8.8	ns
t_{dis}	disable time	$\overline{OE}$ to An	1.4	9.0	1.4	9.0	1.4	9.0	1.4	9.0	1.4	9.0	ns
		$\overline{OE}$ to Bn	2.3	31	2.3	29.6	1.8	11.0	1.7	9.3	0.9	6.9	ns
t_{en}	enable time	$\overline{OE}$ to An	1.0	10.9	1.0	10.9	1.0	10.9	1.0	10.9	1.0	10.9	ns
		$\overline{OE}$ to Bn	1.7	32	1.7	28.2	1.5	12.9	1.2	9.4	1.0	6.9	ns
$V_{CC(A)}$ = 3.3 V ± 0.3 V													
t_{pd}	propagation delay	An to Bn	1.5	23	1.5	21.2	1.1	8.8	0.8	6.3	0.5	4.4	ns
		Bn to An	0.8	15	0.8	7.2	0.8	6.2	0.7	6.1	0.6	6.0	ns
t_{dis}	disable time	$\overline{OE}$ to An	1.6	8.2	1.6	8.2	1.6	8.2	1.6	8.2	1.6	8.2	ns
		$\overline{OE}$ to Bn	2.1	30	2.1	29.0	1.7	10.3	1.5	8.6	0.8	6.3	ns
t_{en}	enable time	$\overline{OE}$ to An	0.8	8.1	0.8	8.1	0.8	8.1	0.8	8.1	0.8	8.1	ns
		$\overline{OE}$ to Bn	1.8	31	1.8	27.7	1.4	12.4	1.1	8.5	0.9	6.4	ns
$V_{CC(A)}$ = 5.0 V ± 0.5 V													
t_{pd}	propagation delay	An to Bn	1.5	22	1.5	21.4	1.0	8.8	0.7	6.0	0.4	4.2	ns
		Bn to An	0.7	13	0.7	7.0	0.4	4.8	0.3	4.5	0.3	4.3	ns
t_{dis}	disable time	$\overline{OE}$ to An	0.3	5.4	0.3	5.4	0.3	5.4	0.3	5.4	0.3	5.4	ns
		$\overline{OE}$ to Bn	2.0	30	2.0	28.7	1.6	9.7	1.4	8.0	0.7	5.7	ns
t_{en}	enable time	$\overline{OE}$ to An	0.7	6.4	0.7	6.4	0.7	6.4	0.7	6.4	0.7	6.4	ns
		$\overline{OE}$ to Bn	1.5	31	1.5	27.6	1.3	11.4	1.0	8.1	0.9	6.0	ns

[1] t_{pd} is the same as t_{PLH} and t_{PHL}; t_{dis} is the same as t_{PLZ} and t_{PHZ}; t_{en} is the same as t_{PZL} and t_{PZH}.

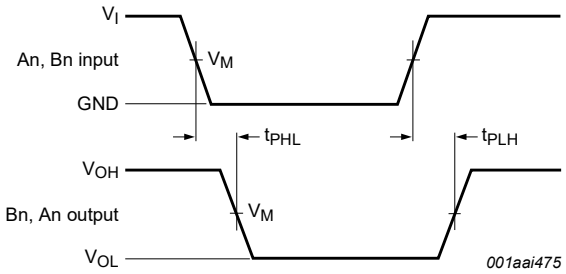
Table 12. Dynamic characteristics for temperature range -40 °C to +125 °C

Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 8; for waveforms see Fig. 6 and Fig. 7. [1]

Symbol	Parameter	Conditions	$V_{CC(B)}$										Unit
			1.5 V ± 0.1 V		1.8 V ± 0.15 V		2.5 V ± 0.2 V		3.3 V ± 0.3 V		5.0 V ± 0.5 V		
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
$V_{CC(A)}$ = 1.5 V ± 0.1 V													
t_{pd}	propagation delay	An to Bn	1.7	32	1.7	27	1.3	21	1.0	18	0.8	16	ns
		Bn to An	0.9	32	0.9	30	0.8	28	0.7	28	0.7	26	ns
t_{dis}	disable time	$\overline{OE}$ to An	1.5	34	1.5	34	1.5	34	1.5	34	1.4	34	ns
		$\overline{OE}$ to Bn	2.4	41	2.4	40	1.9	18	1.7	17	1.3	15	ns
t_{en}	enable time	$\overline{OE}$ to An	0.4	40	0.4	40	0.4	40	0.4	40	0.4	40	ns
		$\overline{OE}$ to Bn	1.8	43	1.8	41	1.5	22	1.2	18	0.9	16	ns
$V_{CC(A)}$ = 1.8 V ± 0.15 V													
t_{pd}	propagation delay	An to Bn	1.7	30	1.7	25.9	1.3	13.2	1.0	11.4	0.8	11.1	ns
		Bn to An	0.9	27	0.9	28.8	0.8	27.6	0.7	27.4	0.7	27.4	ns
t_{dis}	disable time	$\overline{OE}$ to An	1.5	34	1.5	33.6	1.5	33.4	1.5	33.3	1.4	33.2	ns
		$\overline{OE}$ to Bn	2.4	40	2.4	36.2	1.9	17.1	1.7	16.0	1.3	14.3	ns
t_{en}	enable time	$\overline{OE}$ to An	0.4	28	0.4	28	0.4	27.8	0.4	27.7	0.4	27.7	ns
		$\overline{OE}$ to Bn	1.8	41	1.8	40	1.5	20	1.2	16.6	0.9	14.8	ns
$V_{CC(A)}$ = 2.5 V ± 0.2 V													
t_{pd}	propagation delay	An to Bn	1.5	28	1.5	25.4	1.2	13	0.8	10.2	0.6	8.8	ns
		Bn to An	1.2	23	1.2	13.3	1.0	13.1	1.0	12.9	0.9	12.8	ns
t_{dis}	disable time	$\overline{OE}$ to An	1.4	13	1.4	13	1.4	13	1.4	13	1.4	13	ns
		$\overline{OE}$ to Bn	2.3	37	2.3	33.6	1.8	15	1.7	14.3	0.9	10.9	ns
t_{en}	enable time	$\overline{OE}$ to An	1.0	17.2	1.0	17.2	1.0	17.3	1.0	17.2	1.0	17.3	ns
		$\overline{OE}$ to Bn	1.7	38	1.7	32.2	1.5	18.1	1.2	14.1	1.0	11.2	ns
$V_{CC(A)}$ = 3.3 V ± 0.3 V													
t_{pd}	propagation delay	An to Bn	1.5	28	1.5	25.2	1.1	12.8	0.8	10.3	0.5	10.4	ns
		Bn to An	0.8	18	0.8	11.2	0.8	10.2	0.7	10.1	0.6	10	ns
t_{dis}	disable time	$\overline{OE}$ to An	1.6	12.2	1.6	12.2	1.6	12.2	1.6	12.2	1.6	12.2	ns
		$\overline{OE}$ to Bn	2.1	36	2.1	33	1.7	14.3	1.5	12.6	0.8	10.3	ns
t_{en}	enable time	$\overline{OE}$ to An	0.8	14.1	0.8	14.1	0.8	13.6	0.8	13.2	0.8	13.6	ns
		$\overline{OE}$ to Bn	1.8	37	1.8	31.7	1.4	18.4	1.1	12.9	0.9	10.9	ns
$V_{CC(A)}$ = 5.0 V ± 0.5 V													
t_{pd}	propagation delay	An to Bn	1.5	26	1.5	25.4	1.0	12.8	0.7	10	0.4	8.2	ns
		Bn to An	0.7	16	0.7	11	0.4	8.8	0.3	8.5	0.3	8.3	ns
t_{dis}	disable time	$\overline{OE}$ to An	0.3	9.4	0.3	9.4	0.3	9.4	0.3	9.4	0.3	9.4	ns
		$\overline{OE}$ to Bn	2.0	36	2.0	32.7	1.6	13.7	1.4	12	0.7	9.7	ns
t_{en}	enable time	$\overline{OE}$ to An	0.7	10.9	0.7	10.9	0.7	10.9	0.7	10.9	0.7	10.9	ns
		$\overline{OE}$ to Bn	1.5	37	1.5	31.6	1.3	18.4	1.0	13.7	0.9	10.7	ns

[1] t_{pd} is the same as t_{PLH} and t_{PHL}; t_{dis} is the same as t_{PLZ} and t_{PHZ}; t_{en} is the same as t_{PZL} and t_{PZH}.

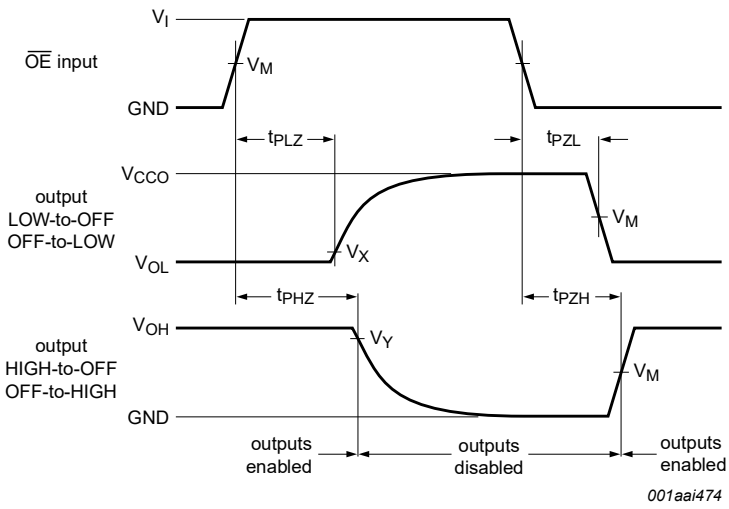
10.1. Waveforms and test circuit



Measurement points are given in Table 13.

V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig. 6. The data input (An, Bn) to output (Bn, An) propagation delay times



Measurement points are given in Table 13.

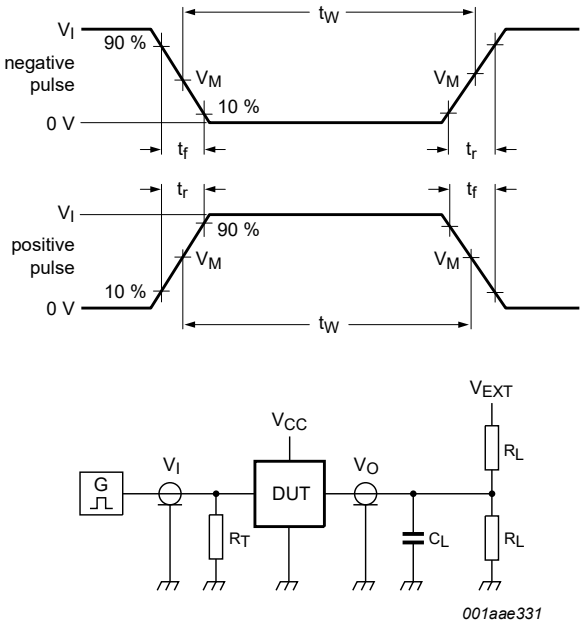
V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig. 7. Enable and disable times

Table 13. Measurement points

Supply voltage	Input [1]	Output [2]		
$V_{CC(A)}$, $V_{CC(B)}$	V_M	V_M	V_X	V_Y
1.2 V to 1.6 V	$0.5V_{CCI}$	$0.5V_{CCO}$	V_{OL} + 0.1 V	V_{OH} - 0.1 V
1.65 V to 2.7 V	$0.5V_{CCI}$	$0.5V_{CCO}$	V_{OL} + 0.15 V	V_{OH} - 0.15 V
3.0 V to 5.5 V	$0.5V_{CCI}$	$0.5V_{CCO}$	V_{OL} + 0.3 V	V_{OH} - 0.3 V

[1] V_{CCI} is the supply voltage associated with the data input port.
[2] V_{CCO} is the supply voltage associated with the output port.



Test data is given in Table 14.

R_L = Load resistance.

C_L = Load capacitance including jig and probe capacitance.

R_T = Termination resistance.

V_{EXT} = External voltage for measuring switching times.

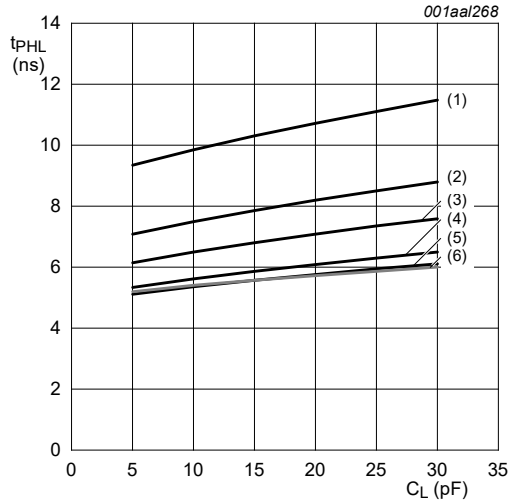
Fig. 8. Test circuit for measuring switching times

Table 14. Test data

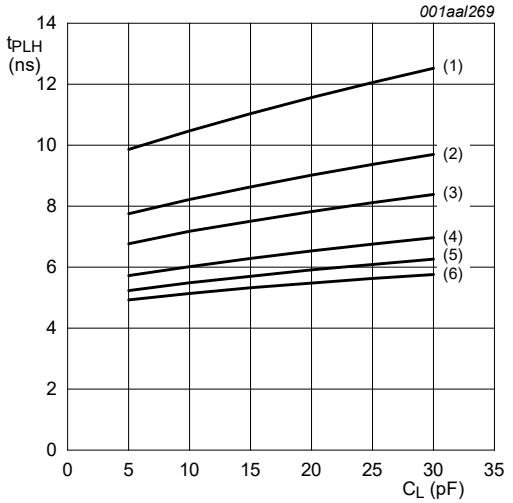
Supply voltage	Input		Load		V_{EXT}		
$V_{CC(A)}$, $V_{CC(B)}$	V_I [1]	Δt/ΔV [2]	C_L	R_L	t_{PLH}, t_{PHL}	t_{PZH}, t_{PHZ}	t_{PZL}, t_{PLZ} [3]
1.2 V to 5.5 V	V_{CCI}	≤ 1.0 ns/V	15 pF	2 kΩ	open	GND	$2V_{CCO}$

[1] V_{CCI} is the supply voltage associated with the data input port.
[2] dV/dt ≥ 1.0 V/ns.
[3] V_{CCO} is the supply voltage associated with the output port.

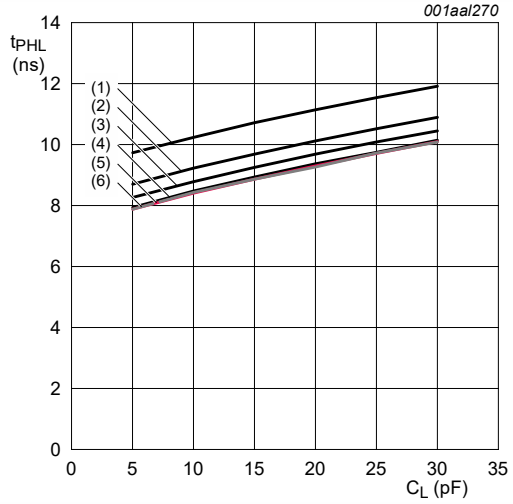
11. Typical propagation delay characteristics



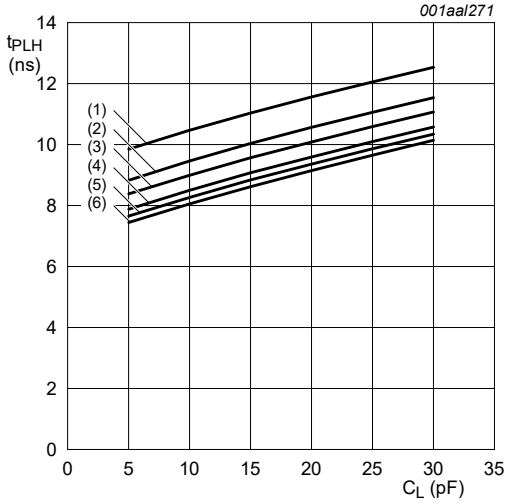
a. HIGH to LOW propagation delay (A to B)



b. LOW to HIGH propagation delay (A to B)



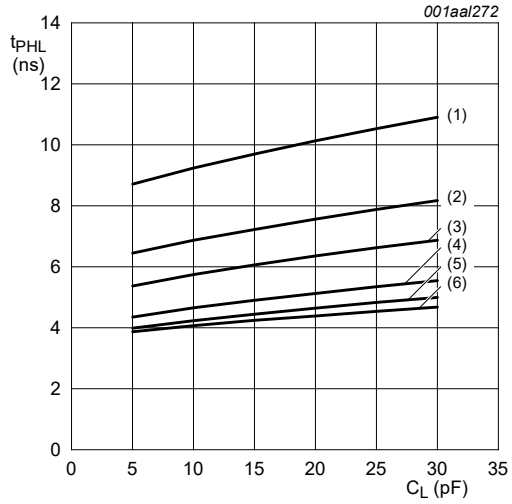
c. HIGH to LOW propagation delay (B to A)



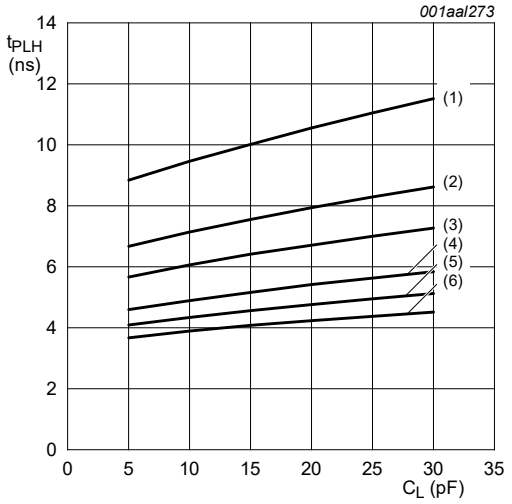
d. LOW to HIGH propagation delay (B to A)

(1) $V_{CC(B)}$ = 1.2 V.
(2) $V_{CC(B)}$ = 1.5 V.
(3) $V_{CC(B)}$ = 1.8 V.
(4) $V_{CC(B)}$ = 2.5 V.
(5) $V_{CC(B)}$ = 3.3 V.
(6) $V_{CC(B)}$ = 5.0 V.

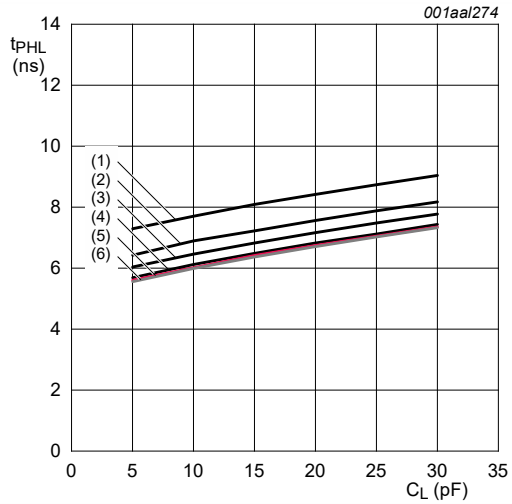
Fig. 9. Typical propagation delay versus load capacitance; T_{amb} = 25 °C; $V_{CC(A)}$ = 1.2 V



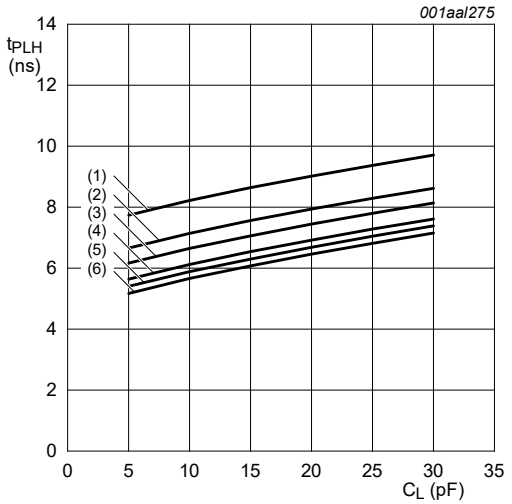
a. HIGH to LOW propagation delay (A to B)



b. LOW to HIGH propagation delay (A to B)



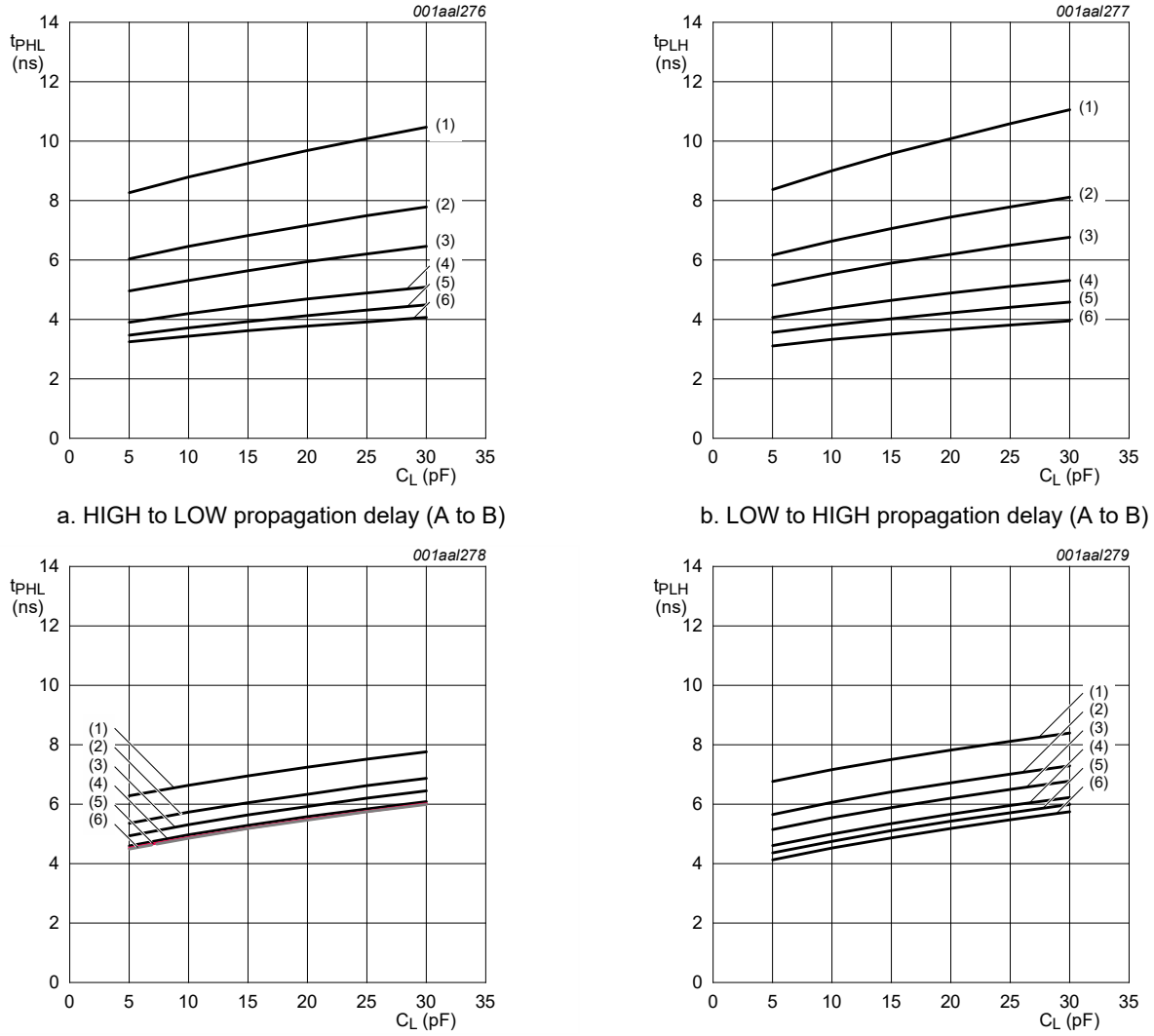
c. HIGH to LOW propagation delay (B to A)



d. LOW to HIGH propagation delay (B to A)

(1) $V_{CC(B)}$ = 1.2 V.
(2) $V_{CC(B)}$ = 1.5 V.
(3) $V_{CC(B)}$ = 1.8 V.
(4) $V_{CC(B)}$ = 2.5 V.
(5) $V_{CC(B)}$ = 3.3 V.
(6) $V_{CC(B)}$ = 5.0 V.

Fig. 10. Typical propagation delay versus load capacitance; T_{amb} = 25 °C; $V_{CC(A)}$ = 1.5 V



a. HIGH to LOW propagation delay (A to B)

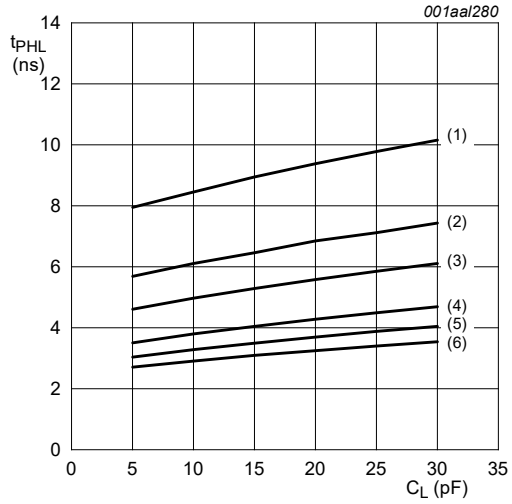
b. LOW to HIGH propagation delay (A to B)

c. HIGH to LOW propagation delay (B to A)

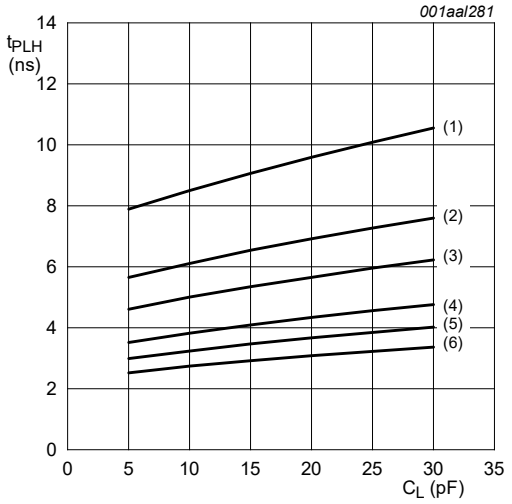
d. LOW to HIGH propagation delay (B to A)

(1) $V_{CC(B)}$ = 1.2 V.
(2) $V_{CC(B)}$ = 1.5 V.
(3) $V_{CC(B)}$ = 1.8 V.
(4) $V_{CC(B)}$ = 2.5 V.
(5) $V_{CC(B)}$ = 3.3 V.
(6) $V_{CC(B)}$ = 5.0 V.

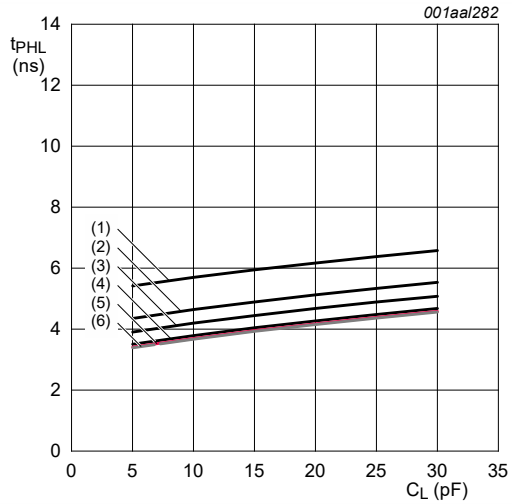
Fig. 11. Typical propagation delay versus load capacitance; T_{amb} = 25 °C; $V_{CC(A)}$ = 1.8 V



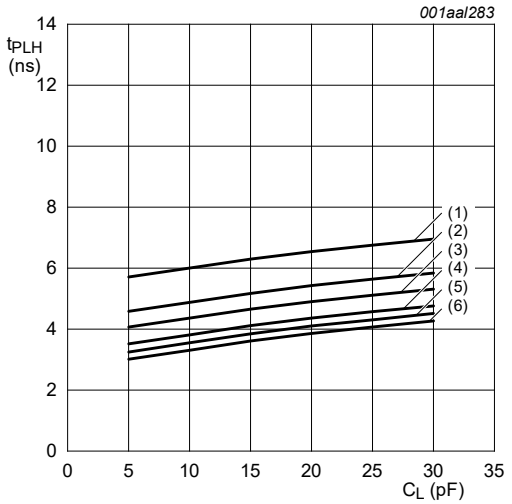
a. HIGH to LOW propagation delay (A to B)



b. LOW to HIGH propagation delay (A to B)



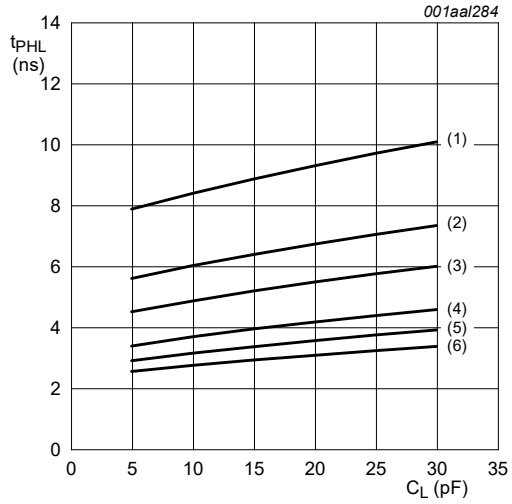
c. HIGH to LOW propagation delay (B to A)



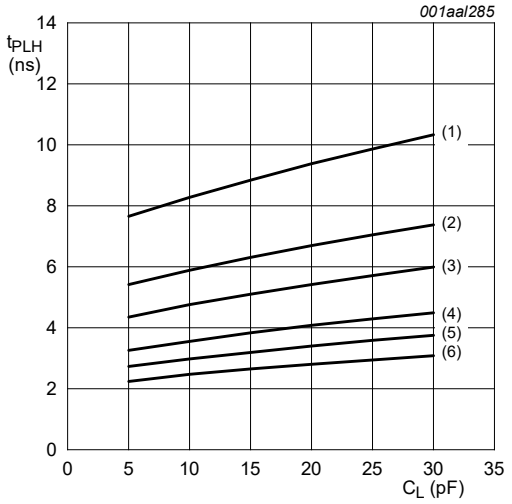
d. LOW to HIGH propagation delay (B to A)

(1) $V_{CC(B)}$ = 1.2 V.
(2) $V_{CC(B)}$ = 1.5 V.
(3) $V_{CC(B)}$ = 1.8 V.
(4) $V_{CC(B)}$ = 2.5 V.
(5) $V_{CC(B)}$ = 3.3 V.
(6) $V_{CC(B)}$ = 5.0 V.

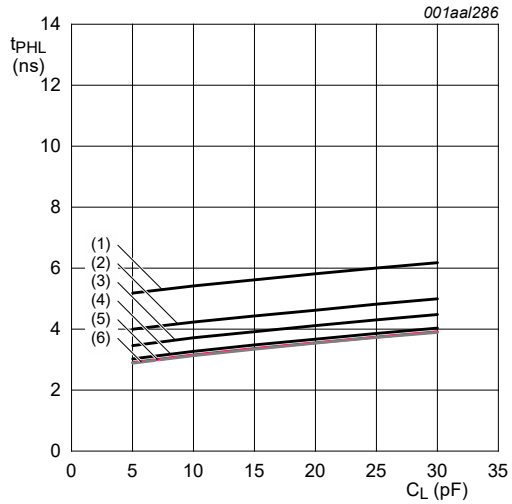
Fig. 12. Typical propagation delay versus load capacitance; T_{amb} = 25 °C; $V_{CC(A)}$ = 2.5 V



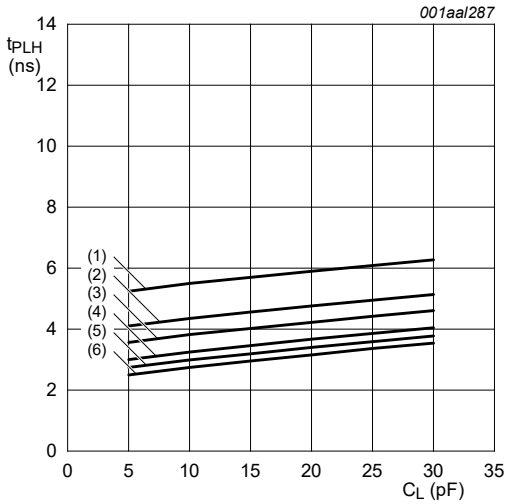
a. HIGH to LOW propagation delay (A to B)



b. LOW to HIGH propagation delay (A to B)



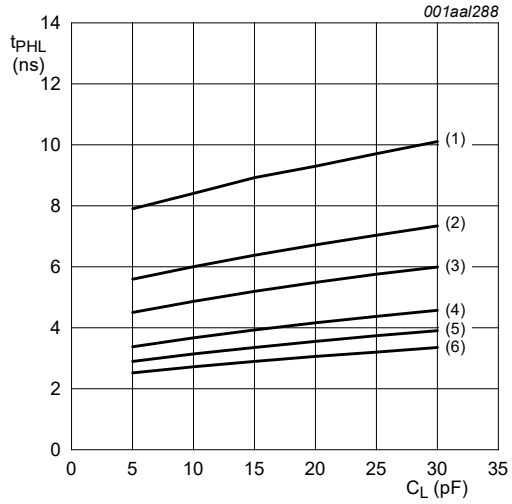
c. HIGH to LOW propagation delay (B to A)



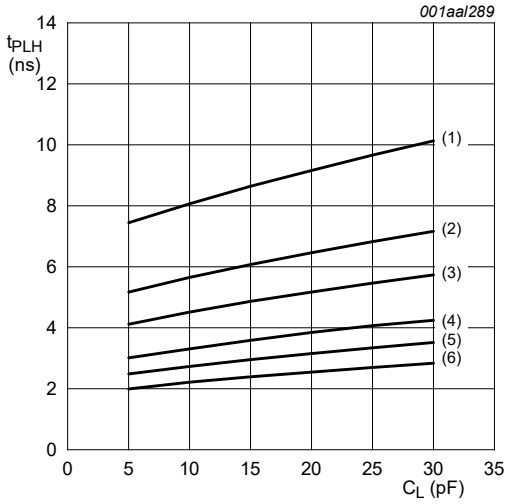
d. LOW to HIGH propagation delay (B to A)

(1) $V_{CC(B)}$ = 1.2 V.
(2) $V_{CC(B)}$ = 1.5 V.
(3) $V_{CC(B)}$ = 1.8 V.
(4) $V_{CC(B)}$ = 2.5 V.
(5) $V_{CC(B)}$ = 3.3 V.
(6) $V_{CC(B)}$ = 5.0 V.

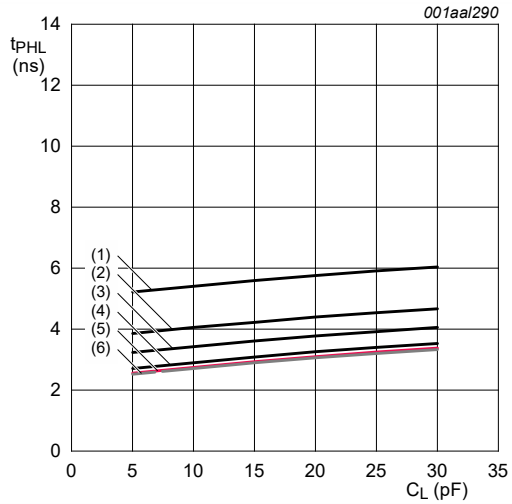
Fig. 13. Typical propagation delay versus load capacitance; T_{amb} = 25 °C; $V_{CC(A)}$ = 3.3 V



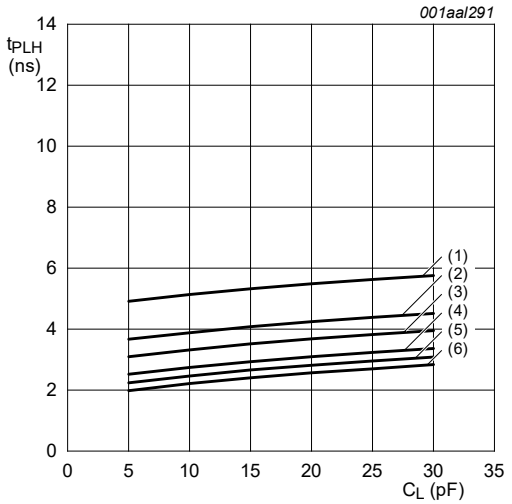
a. HIGH to LOW propagation delay (A to B)



b. LOW to HIGH propagation delay (A to B)



c. HIGH to LOW propagation delay (B to A)



d. LOW to HIGH propagation delay (B to A)

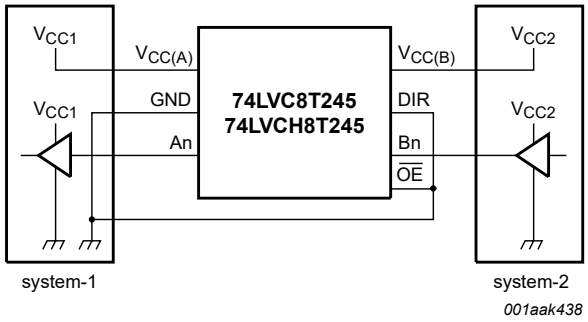
(1) $V_{CC(B)}$ = 1.2 V.
(2) $V_{CC(B)}$ = 1.5 V.
(3) $V_{CC(B)}$ = 1.8 V.
(4) $V_{CC(B)}$ = 2.5 V.
(5) $V_{CC(B)}$ = 3.3 V.
(6) $V_{CC(B)}$ = 5.0 V.

Fig. 14. Typical propagation delay versus load capacitance; T_{amb} = 25 °C; $V_{CC(A)}$ = 5 V

12. Application information

12.1. Unidirectional logic level-shifting application

The circuit given in Fig. 15 is an example of the 74LVC8T245; 74LVCH8T245 being used in an unidirectional logic level-shifting application.



Schematic given for one channel.

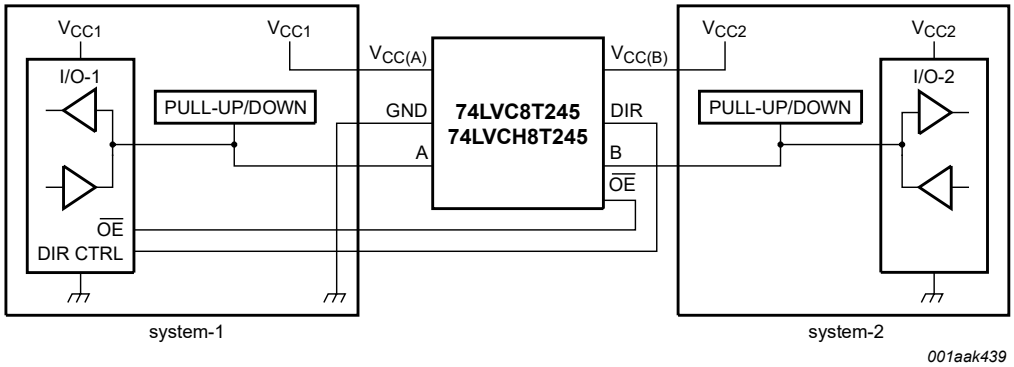
Fig. 15. Unidirectional logic level-shifting application

Table 15. Description unidirectional logic level-shifting application

Name	Function	Description
$V_{CC(A)}$	V_{CC1}	supply voltage of system-1 (1.2 V to 5.5 V)
GND	GND	device GND
A	OUT	output level depends on V_{CC1} voltage
B	IN	input threshold value depends on V_{CC2} voltage
DIR	DIR	the GND (LOW level) determines B port to A port direction
$V_{CC(B)}$	V_{CC2}	supply voltage of system-2 (1.2 V to 5.5 V)
$\overline{OE}$	$\overline{OE}$	The GND (LOW level) enables the output ports

12.2. Bidirectional logic level-shifting application

Fig. 16 shows the 74LVC8T245; 74LVCH8T245 being used in a bidirectional logic level-shifting application.



Schematic given for one channel.

Pull-up or pull-down only needed for 74LVC8T245.

Fig. 16. Bidirectional logic level-shifting application

Table 16 gives a sequence that will illustrate data transmission from system-1 to system-2 and then from system-2 to system-1.

Table 16. Description bidirectional logic level-shifting application

H = HIGH voltage level; L = LOW voltage level; Z = high-impedance OFF-state.

State	DIR CTRL	$\overline{OE}$	I/O-1	I/O-2	Description
1	H	L	output	input	system-1 data to system-2
2	H	H	Z	Z	system-2 is getting ready to send data to system-1. I/O-1 and I/O-2 are disabled. The bus-line state depends on bus hold.
3	L	H	Z	Z	DIR bit is set LOW. I/O-1 and I/O-2 still are disabled. The bus-line state depends on bus hold.
4	L	L	input	output	system-2 data to system-1

12.3. Power-up considerations

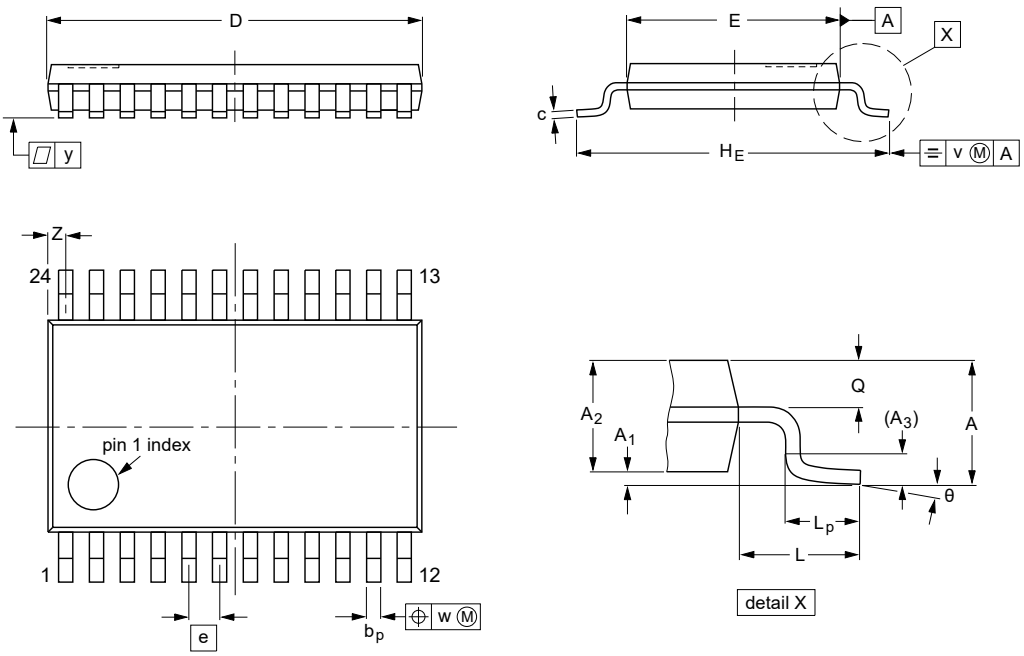
The device is designed such that no special power-up sequence is required other than GND being applied first.

Table 17. Typical total supply current ($I_{CC(A)}$ + $I_{CC(B)}$)

$V_{CC(A)}$	$V_{CC(B)}$					Unit
	0 V	1.8 V	2.5 V	3.3 V	5.0 V	
0 V	0	< 1	< 1	< 1	< 1	µA
1.8 V	< 1	< 2	< 2	< 2	2	µA
2.5 V	< 1	< 2	< 2	< 2	< 2	µA
3.3 V	< 1	< 2	< 2	< 2	< 2	µA
5.0 V	< 1	2	< 2	< 2	< 2	µA

13. Package outline

TSSOP24: plastic thin shrink small outline package; 24 leads; body width 4.4 mm **SOT355-1**



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A_1	A_2	A_3	b_p	c	$D^{(1)}$	$E^{(2)}$	e	H_E	L	L_p	Q	v	w	y	$Z^{(1)}$	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	7.9 7.7	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.5 0.2	8° 0°

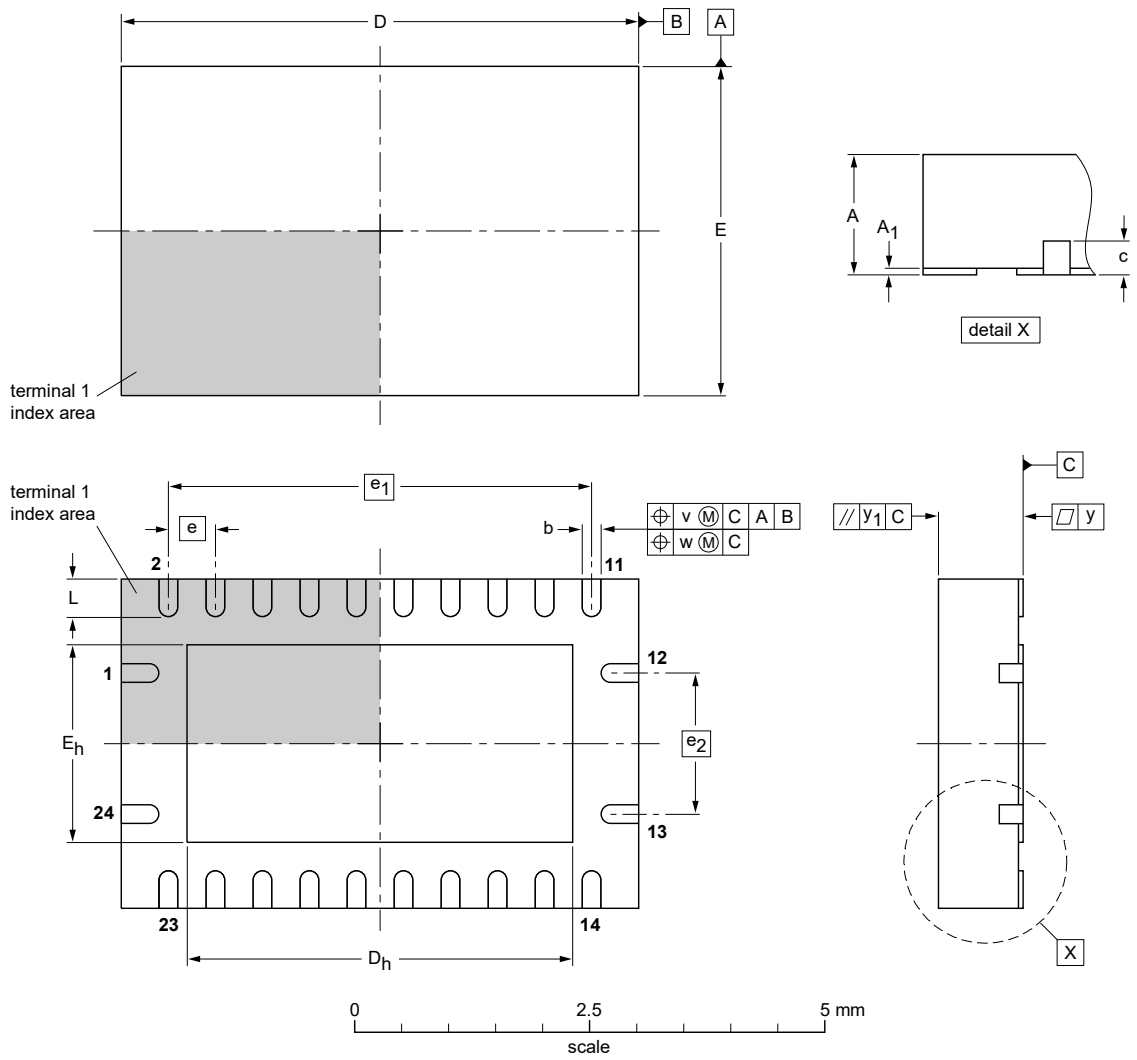
Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT355-1		MO-153				~~99-12-27~~ 03-02-19

Fig. 17. Package outline SOT355-1 (TSSOP24)

DHVQFN24: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 24 terminals; body 3.5 x 5.5 x 0.85 mm **SOT815-1**



DIMENSIONS (mm are the original dimensions)

UNIT	$A^{(1)}$ max.	A_1	b	c	$D^{(1)}$	D_h	$E^{(1)}$	E_h	e	e_1	e_2	L	v	w	y	y_1
mm	1	0.05 0.00	0.30 0.18	0.2	5.6 5.4	4.25 3.95	3.6 3.4	2.25 1.95	0.5	4.5	1.5	0.5 0.3	0.1	0.05	0.05	0.1

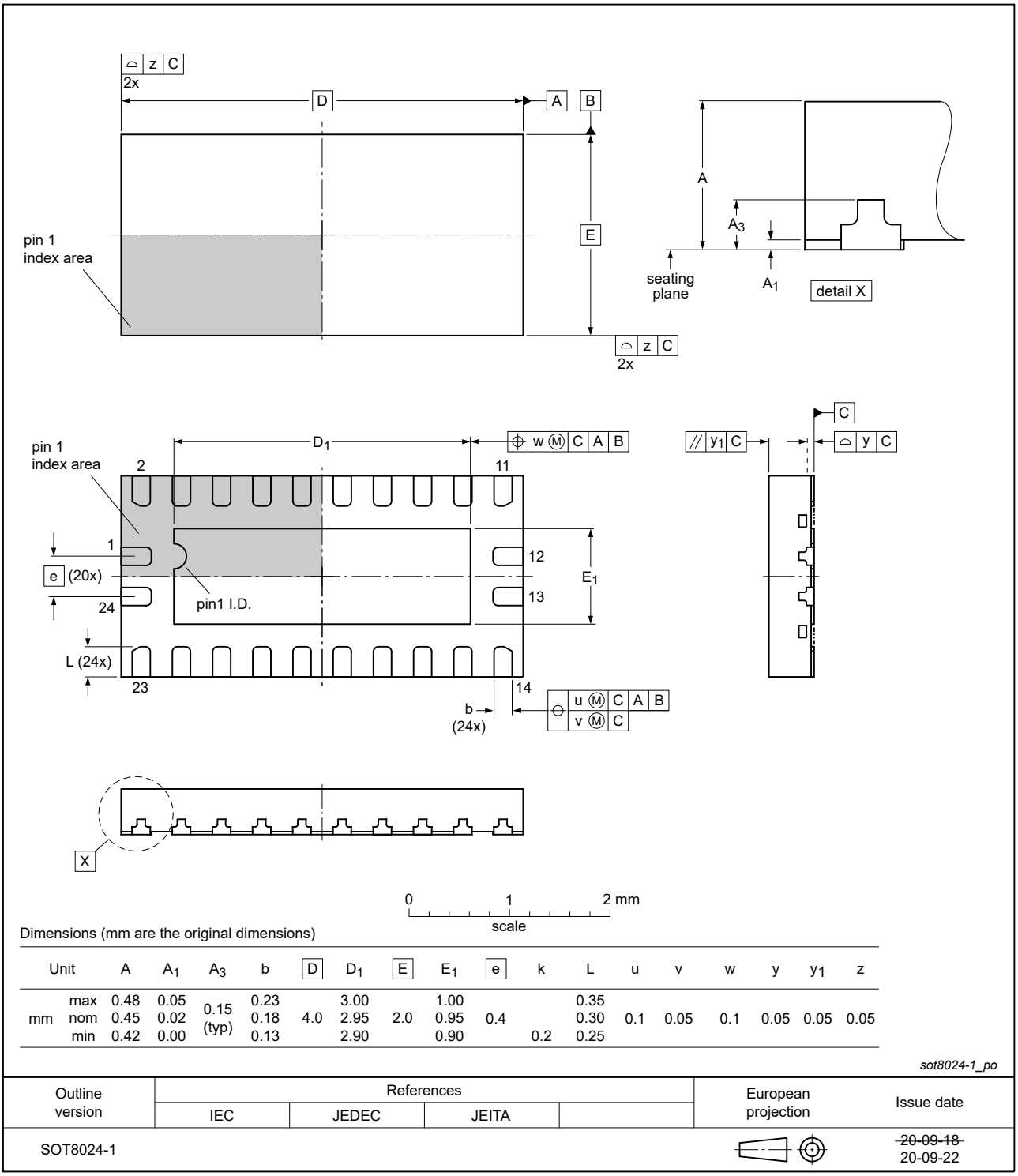
Note

1. Plastic or metal protrusions of 0.075 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT815-1	- - -	- - -	- - -			03-04-29

Fig. 18. Package outline SOT815-1 (DHVQFN24)

DHXQFN24: plastic, leadless dual in-line compatible thermal enhanced extreme thin quad flat package; no leads; 24 terminals; 0.4 mm pitch; body 2 mm x 4 mm x 0.48 mm **SOT8024-1**



Dimensions (mm are the original dimensions)

Unit	A	A_1	A_3	b	D	D_1	E	E_1	e	k	L	u	v	w	y	y_1	z
max	0.48	0.05	0.15 (typ)	0.23	4.0	3.00	2.0	1.00	0.4		0.35	0.1	0.05	0.1	0.05	0.05	0.05
mm nom	0.45	0.02		0.18		2.95		0.95			0.30						
min	0.42	0.00		0.13		2.90		0.90		0.2	0.25						

sot8024-1_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT8024-1						~~20-09-18~~ 20-09-22

Fig. 19. Package outline SOT8024-1 (DHXQFN24)

14. Abbreviations

Table 18. Abbreviations

Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model

15. Revision history

Table 19. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC_LVCH8T245 v.5	20210429	Product data sheet	-	74LVC_LVCH8T245 v.4
Modifications:	• Type number 74LVC8T245BZ (SOT8024-1 / DHXQFN24) added.			
74LVC_LVCH8T245 v.4	20200922	Product data sheet	-	74LVC_LVCH8T245 v.3
Modifications:	• The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. • Legal texts have been adapted to the new company name where appropriate. • Table 4: Derating values for P_{tot} total power dissipation updated.			
74LVC_LVCH8T245 v.3	20111212	Product data sheet	-	74LVC_LVCH8T245 v.2
Modifications:	• Legal pages updated.			
74LVC_LVCH8T245 v.2	20110211	Product data sheet	-	74LVC_LVCH8T245 v.1
74LVC_LVCH8T245 v.1	20100111	Product data sheet	-	-

16. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.
[2] The term 'short data sheet' is explained in section "Definitions".
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